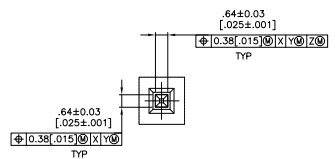
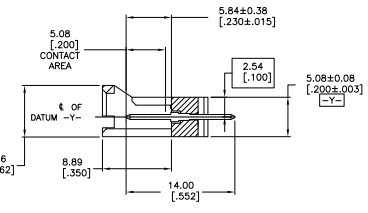
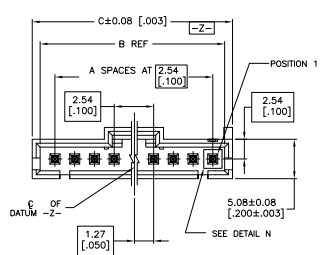
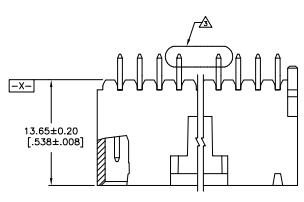
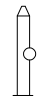


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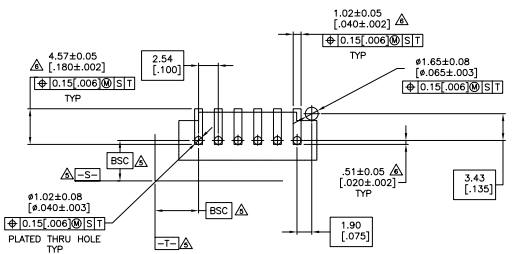
REV	DATE	DESCRIPTION	BY	CHK	APP
AD	00				
D	EC	023C 0789 04	AREBOS	BSV	JLG



DETAIL N  
SCALE 10:1



DETAIL Z  
POST DETAIL TYP  
2 POST MINIMUM  
SCALE 10:1



RECOMMENDED PC BOARD MOUNTING DIMENSIONS  
 RECOMMENDED STENCIL THICKNESS = 0.25[.010]

- ⚠ HOUSING: HIGH TEMPERATURE THERMOPLASTIC, COLOR-BLACK.  
POST: BRASS
- ⚠ FINISH: 0.00076 [.000030] MIN GOLD ON THE CONTACT AREA,  
0.00254 [.000100] MIN MATTE TIN ON REMAINDER  
OF CONTACT, ALL OVER 0.00127 [.000050] NICKEL.
- ⚠ SELECT POST TAILS FORMED TO PROVIDE CONNECTOR  
HOLD DOWN UNTIL SOLDERED, CONFIGURATION ACCEPTS 0.69-2.03  
[.027-.080] THICK PRINTED CIRCUIT BOARD.(SEE DETAIL Z)
- 4. PARTS ARE PACKAGED IN GANG TUBES.
- ⚠ DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
- ⚠ DIMENSIONS NOTED ARE FOR SOLDER STENCIL LAYOUT FOR  
USE WITH 1.58±0.20 [.062±.008] THICK PRINTED CIRCUIT BOARDS.
- ⚠ PRELIMINARY PART-NOT RELEASED FOR PRODUCTION.
- ⚠ FINISH: 0.00076 [.000030] MIN GOLD ON THE CONTACT AREA,  
0.00254 [.000100] MIN MATTE TIN ON REMAINDER OF  
CONTACT, ALL OVER 0.00127 [.000050] NICKEL.

PLATING	C	B	A	NO. OF POSN	PART NO.
⚠	27.94 [1.100]	25.91 [1.020]	9	10	5-147245-9
⚠	22.86 [.900]	20.83 [.820]	7	8	5-147245-7
⚠	7.62 [.300]	5.59 [.220]	1	2	5-147245-1
⚠	27.94 [1.100]	25.91 [1.020]	9	10	147245-9
⚠	22.86 [.900]	20.83 [.820]	7	8	147245-7
⚠	7.62 [.300]	5.59 [.220]	1	2	147245-1

REV	DATE	DESCRIPTION	BY	CHK	APP
A1	00779	C=147245			